

Vishay Siliconix

RoHS

COMPLIANT

HALOGEN

P-Channel 30 V (D-S) MOSFET

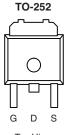
PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
- 30	0.0087 at V _{GS} = - 10 V	- 45 ^d	60	
- 30	0.0150 at V _{GS} = - 4.5 V	- 32	00	

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % $\rm R_{g}$ and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

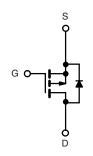
- Power Switch
- Load Switch in High Current Applications
- DC/DC Converters



Drain Connected to Tab



Ordering Information: SUD45P03-09-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_C = 25 \ ^{\circ}C$, unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 30	v		
Gate-Source Voltage		V _{GS}	± 20	- V	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 25 °C	1-	- 45 ^d		
Continuous Drain Current (1) = 150°C)	T _C = 70 °C	I _D	- 42.5	А	
Pulsed Drain Current		I _{DM}	- 100		
Avalanche Current		I _{AS}	- 35		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	61	mJ	
Maximum Davier Disain ational	T _C = 25 °C	P	41.7 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	- P _D -	2.1	vv	
Operating Junction and Storage Temperature Ran	nge	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	60	°C/W		
Junction-to-Case (Drain)	R _{thJC}	3	0/10		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

d. Package limited.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	· · · ·		•			
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 30			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 125 °C			50	50 μA 250	
		V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 50			Α	
	Б	V _{GS} = - 10 V, I _D = - 20 A		0.0072	0.0087	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 15 A		0.0125	0.0150		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 20 A		45		S	
Dynamic ^b		· · · · ·					
Input Capacitance	C _{iss}			2700		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 15 V, f = 1 MHz		515			
Reverse Transfer Capacitance	C _{rss}			445			
Total Gate Charge ^c	Qg			60	90	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -20 \text{ A}$		9.3			
Gate-Drain Charge ^c	Q _{gd}			15			
Gate Resistance	Rg	f = 1 MHz	0.5	2.5	5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			12	20		
Rise Time ^c	t _r	V_{DD} = - 15 V, R_L = 1.5 Ω		11	20	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		40	60		
Fall Time ^c	t _f			12	20		
Drain-Source Body Diode Ratings a	nd Characteri	stics T _C = 25 °C ^b					
Continuous Current	ا _S				- 45		
Pulsed Current	I _{SM}				- 100	A	
Forward Voltage ^a	V _{SD}	I _F = - 10 A, V _{GS} = 0 V		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			27	40	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 10 A, dI/dt = 100 A/μs		1.3	2	А	
Reverse Recovery Charge	Q _{rr}	1 1		20	30	nC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

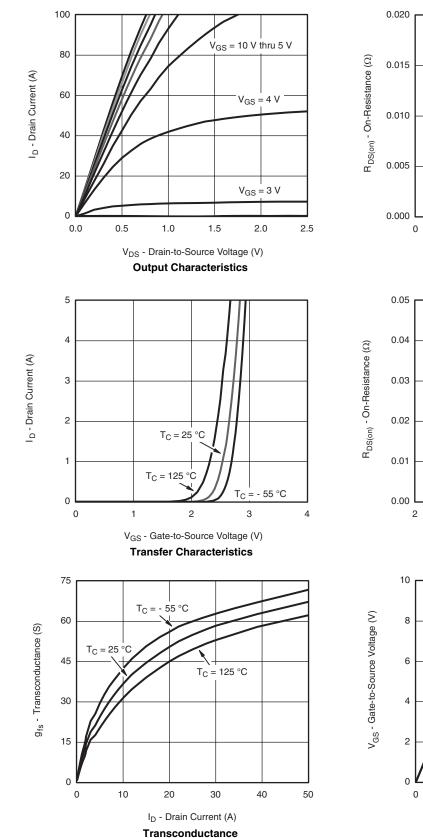
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

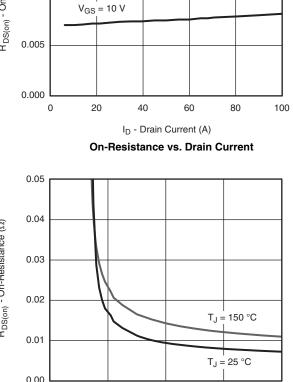


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 $V_{GS} = 4.5 V$

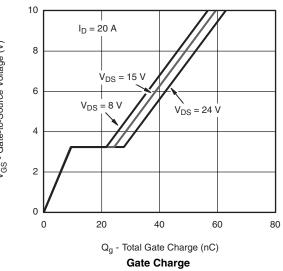
V_{GS} - Gate-to-Source Voltage (V) On-Resistance vs. Gate-to-Source Voltage

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8

10

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Document Number: 65595 S10-0460-Rev. B, 22-Feb-10



150

125

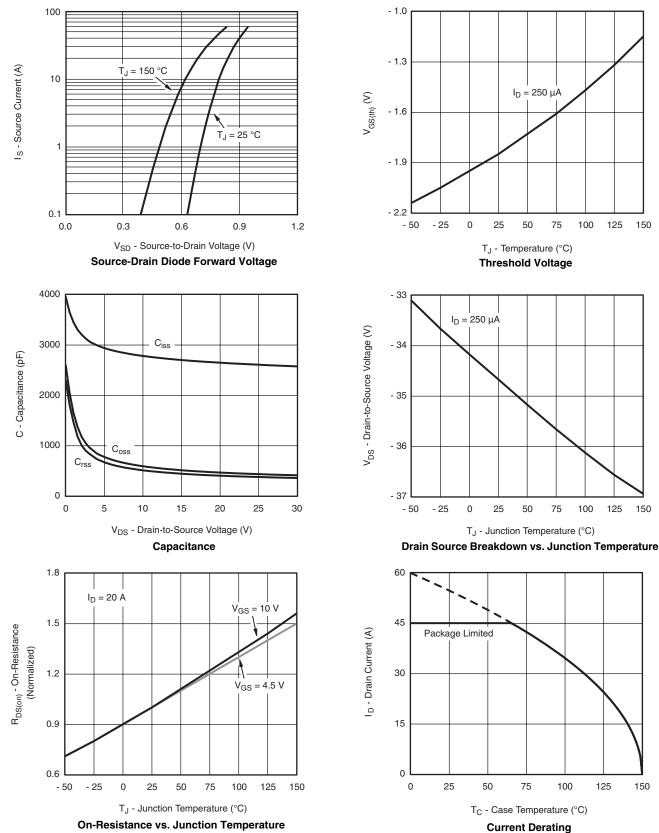
125

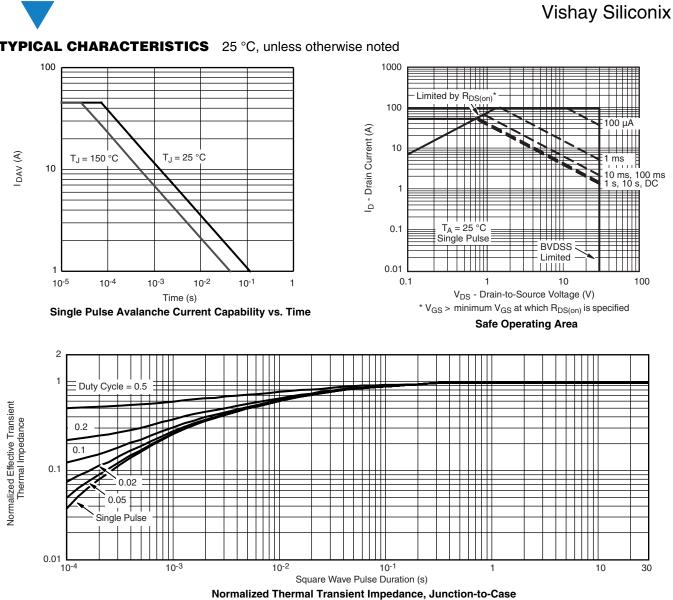
150

150

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

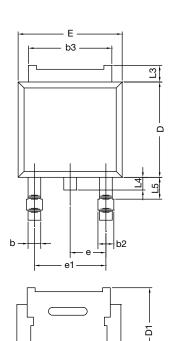
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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65595.

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TO-252AA Case Outline

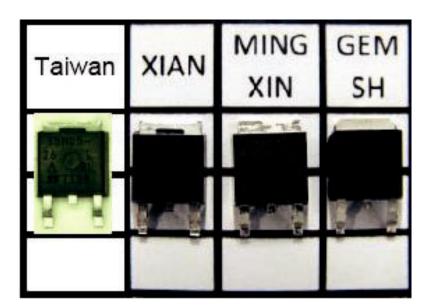
	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
е	2.28 BSC		0.090 BSC	
e1	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060
ECN: T13-0359-Rev. O, 03-Jun-13 DWG: 5347				

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Notes

• Dimension L3 is for reference only.

• Xi'an, Mingxin, and GEM SH actual photo.



Revision: 03-Jun-13

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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